

Docket No.: 50103-421

UTILITY PATENT APPLICATION
UNDER 37 CFR 1.53(b)

Box PATENT APPLICATION
Commissioner for Patents
Washington, DC 20231
Sir:



Transmitted herewith for filing is the patent application of:

INVENTOR: Wen LIU, Yao-Tzung SHIH, Taesun KIM, Chung SHIH
FOR: ULTRA-THIN, CORROSION- RESISTANT, HYDROGENATED CARBON
OVERCOATS BY COMBINED SPUTTERING AND PECVD

Enclosed are:

- ☒ 24 pages of specification, claims, abstract.
- ☒ Declaration and Power of Attorney.
- ☒ Priority Claimed United States Provisional Application Serial No. 60/308,146.
- ☐ Certified copy of _____
- ☒ 3 sheets of informal drawing.
- ☒ An assignment of the invention to SEAGATE TECHNOLOGY LLC
and the assignment recordation fee.
- ☐ An associate power of attorney.
- ☐ A verified statement to establish small entity status under 37 CFR 1.9 and 37 CFR 1.27.
- ☐ Information Disclosure Statement, Form PTO-1449 and reference.
- ☒ Return Receipt Postcard
- ☒ Non-Publication Request

The filing fee has been calculated as shown below:

	NO. OF CLAIMS		EXTRA CLAIMS	RATE	AMOUNT
Total Claims	26	-20	6	\$18.00	\$108.00
Independent Claims	5	-3	2	\$84.00	\$168.00
Multiple Dependent Claim(s)					\$0.00
Basic Fee					\$740.00
Total of Above Calculations					\$1,016.00
Less 1/2 for Small Entity					\$0.00
Assignment & Recording Fee					\$40.00
Total Fee					\$1,056.00



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PATENT TRADEMARK OFFICE

Burden Hour Statement This collection of information is required by 37 CFR 1.213(a). The information is used by the public to request that an application not be published under 35 U.S.C. 122(b) (and the PTO to process that request). Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. This form is estimated to take 6 minutes to complete. This time will vary depending upon the needs of the individual case. Any comments on the amount of time you are required to complete this form should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, Washington, DC 20231. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Commissioner for Patents, Washington, DC 20231.